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Vishay/Siliconix SI8402DB-T1-E1

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# **Si8402DB**

Vishay Siliconix

# 20 V N-Channel 1.8 V (G-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)			
	0.037 at V <sub>GS</sub> = 4.5 V	7.3			
20	0.039 at V <sub>GS</sub> = 2.5 V	7.1			
	0.043 at V <sub>GS</sub> = 1.8 V	6.8			

### **FEATURES**

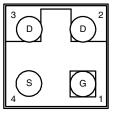
- TrenchFET<sup>®</sup> Power MOSFET
- MICRO FOOT® Chipscale Packaging Reduces Footprint Area Profile (0.62 mm) and On-Resistance Per Footprint Area
- Material categorization:
   For definitions of compliance please see www.vishay.com/doc?99912





### **MICRO FOOT**

Bump Side View



8402 xxx

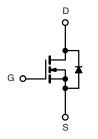
Backside View

Device Marking: 8402

xxx = Date/Lot Traceability Code

### **APPLICATIONS**

 PA, Battery and Load Switch for Portable Devices



N-Channel MOSFET

Ordering Information: Si8402DB-T1-E1 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b>	(T <sub>A</sub> = 25 °C, unle	ss otherwise	noted)		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	20		V
Gate-Source Voltage		V <sub>GS</sub>	± 8		
Ocation and Ducing October 17 150 2003	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	7.3	5.3	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		5.9	4.3	
Pulsed Drain Current		I <sub>DM</sub>	30		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	2.3	1.2	
	T <sub>A</sub> = 25 °C	В	2.77	1.47	W
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	- P <sub>D</sub>	1.77	0.94	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C
Package Reflow Conditions <sup>b</sup>	IR/Convection		260		C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 5 s	D	35	45		
Maximum Junction-to-Ambient <sup>a</sup>	Steady State	- R <sub>thJA</sub>	72	85	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	16	20		

### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. Refer to IPC/JEDEC (J-STD-020), no manual or hand soldering.

Document Number: 72657 S13-1703-Rev. D, 29-Jul-13 For technical questions, contact: <a href="mailto:pmostechsupport@vishay.com">pmostechsupport@vishay.com</a>

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Datasheet of SI8402DB-T1-E1 - MOSFET N-CH 20V 5.3A 2X2 4-MFP

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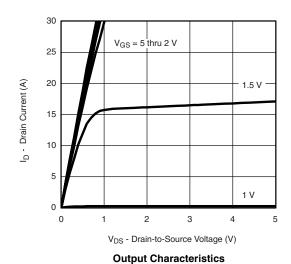
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4		1	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zana Oata Valta na Duain Ourmant	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C			5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	5			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 1 \text{ A}$		0.031 0.037			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_D = 1 \text{ A}$		0.033	0.039	Ω	
		$V_{GS} = 1.8 \text{ V}, I_D = 1 \text{ A}$		0.035	0.043		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 A		12		S	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V		0.8	1.2	٧	
Dynamic <sup>b</sup>			•				
Total Gate Charge	$Q_g$			17	26		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 1 \text{ A}$		2		nC	
Gate-Drain Charge	$Q_{gd}$			3.1			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		15		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			30	45		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 10 $\Omega$		45	70	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 1 A, $V_{GEN}$ = 4.5 V, $R_g$ = 6 $\Omega$		145	220		
Fall Time	t <sub>f</sub>			75	115		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 1 A, dI/dt = 100 A/μs		30	60		

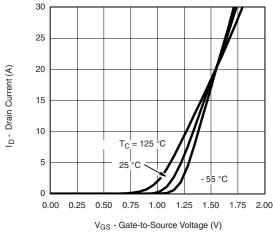
### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Transfer Characteristics

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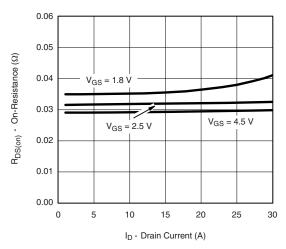




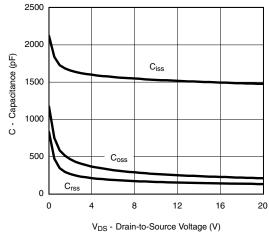
# **Si8402DB**

# Vishay Siliconix

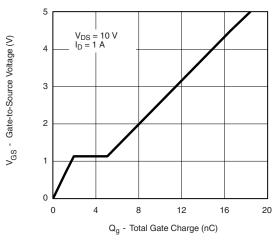
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



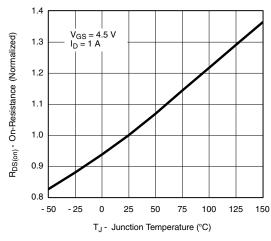
### On-Resistance vs. Drain Current



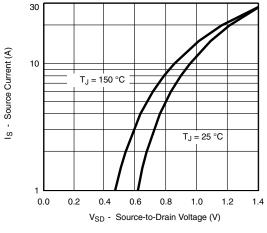
Capacitance



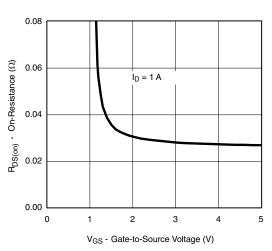
**Gate Charge** 



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

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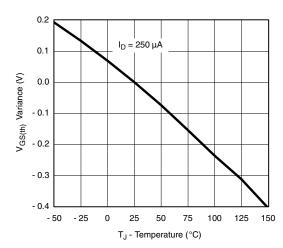
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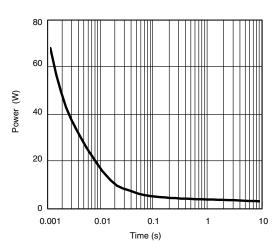


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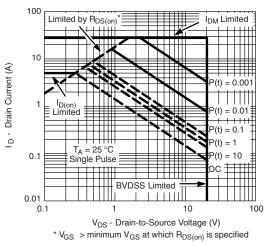
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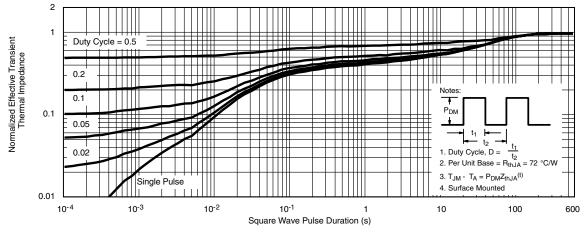


**Threshold Voltage** 

Single Pulse Power, Junction-to-Ambient



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

Datasheet of SI8402DB-T1-E1 - MOSFET N-CH 20V 5.3A 2X2 4-MFP

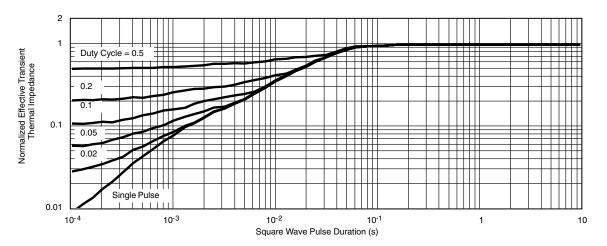
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# **Si8402DB**

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Datasheet of SI8402DB-T1-E1 - MOSFET N-CH 20V 5.3A 2X2 4-MFP

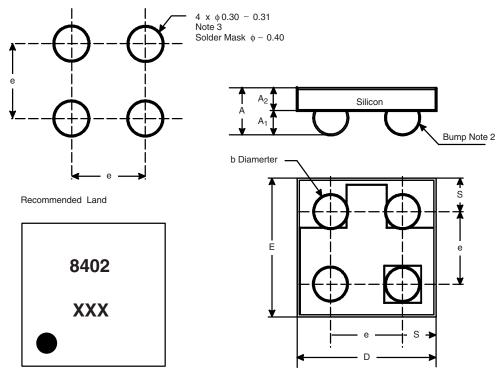
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### **PACKAGE OUTLINE**

### MICRO FOOT: 4-BUMP (0.8 mm PITCH)



Mark on Backside of Die

Notes (Unless Otherwise Specified):

- 1. Laser mark on the silicon die back, coated with a thin metal.
- 2. Bumps are 95.5/3.8/0.7 Sn/Ag/Cu.
- 3. Non-solder mask defined copper landing pad.
- 4. The flat side of wafers is oriented at the bottom.

Dim.	Millimeters <sup>a</sup>		Inches		
	Min.	Max.	Min.	Max.	
Α	0.600	0.650	0.0236	0.0256	
A <sub>1</sub>	0.260	0.290	0.0102	0.0114	
A <sub>2</sub>	0.340	0.360	0.0134	0.0142	
b	0.370	0.410	0.0146	0.0161	
D	1.520	1.600	0.0598	0.0630	
E	1.520	1.600	0.0598	0.0630	
е	0.800		0.0315		
S	0.360	0.400	0.0142	0.0157	

### Notes:

a. Use millimeters as the primary measurement.

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Datasheet of SI8402DB-T1-E1 - MOSFET N-CH 20V 5.3A 2X2 4-MFP

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